SDLS006

D2634, JANUARY 1981 REVISED MARCH 1988

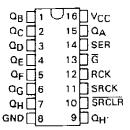
- 8-Bit Serial-In, Parallel-Out Shift Registers with Storage
- Choice of 3-State ('LS595) or Open-Collector ('LS596) Parallel Outputs
- Shift Register Has Direct Clear
- Accurate Shift Frequency: DC to 20 MHz

description

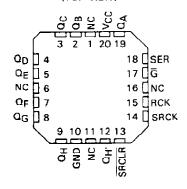
These devices each contain an 8-bit serial-in, parallel-out shift register that feeds an 8-bit D-type storage register. The storage register has parallel 3-state ('LS595) or open-collector ('LS596) outputs. Separate clocks are provided for both the shift register and the storage register. The shift register has a direct-overriding clear, serial input, and serial output pins for cascading.

Both the shift register and storage register clocks are positive-edge triggered. If the user wishes to connect both clocks together, the shift register state will always be one clock pulse ahead of the storage register.

SN54LS595, SN54LS596...J OR W PACKAGE SN74LS595, SN74LS596...N PACKAGE (TOP VIEW)

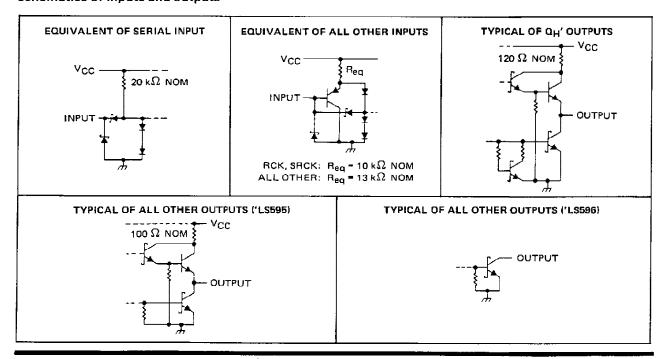


SN54LS595, SN54LS596 . . . FK PACKAGE (TOP VIEW)



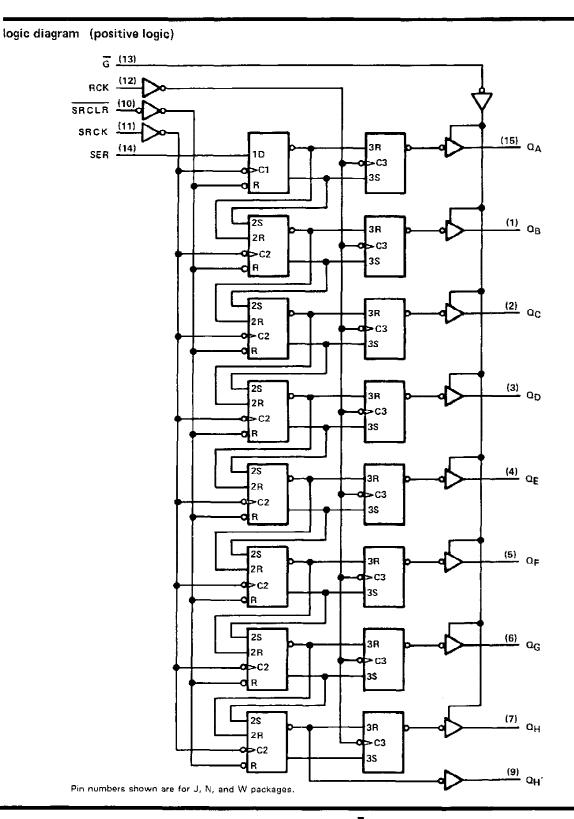
NC - No internal connection

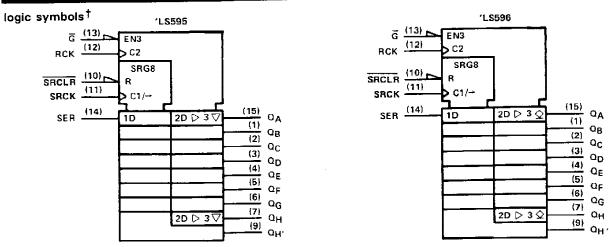
schematics of inputs and outputs



PRODUCTION DATA documents contain information current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.







 $^{^{\}dagger}$ These symbols are in accordance with ANSI/IEEE Std. 91-1984 and IEC Publication 617-12. Pin numbers shown are for J, N, and W packages.

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, Vcc (see Note 1)		
Input voltage		
Offictate output voltage		, , , , , , , , , , , , , , , , , , ,
Operation free-air temperature range:	SN54LS595, SN54LS596	, - 55°C to 125°C
	SN741 S595, SN74LS596	
Storage temperature range	.,,	

NOTE 1: Voltage values are with respect to the network ground terminal.

recommended operating conditions

· · · · · · · · · · · · · · · · · · ·			SN54LS'			SN74LS'			UNIT	
			MIN	NOM	MAX	MIN	NOM	MAX	ON	
V _{CC}	Supply voltage		4.5	5	5.5	4.75	5	5.25		
VIH	High-level input voltage		2			2			V	
VIL	Low-level input voltage				0.7			0.8	V	
VOH	High-level output voltage	QA thru QH, 'LS596 only			5.5			5 .5	V	
		QH,			-1			- 1	mA	
	High-level output current	Q _A thru Q _H , 'L\$595 only			- 1			– 2.6		
toL L	Low-level output current	QH'			8			16	mA	
		Q			12		- '	24		
fSRCK	Shift clock frequency	1	0		20	0		20	МН	
tw(SRCK)	Duration of shift clock pulse					25			ns	
tw(RCK)	Duration of register clock pulse					20			ns	
tw(SRCLR)						20			ns	
t _{sti} Setup time		SRCLR inactive before SRCK 1	20			20				
		SER before SRCK t	20			20				
	Setup time	SRCK † before RCK † (see Note 2)	40			40			ns	
		SRCLR low before RCK f	40		-	40				
^t h	Hold time	SER after SRCK 1	0			0			ns	
T _A	Operating free-air temperature				125	0		70	°C	

NOTE 2: This setup time ensures the register will see stable data from the shift-register outputs. The clocks may be connected together, in which case the storage register state will be one clock pulse behind the shift register.



SN54LS595, SN54LS596, SN74LS595, SN74LS596 8-BIT SHIFT REGISTERS WITH OUTPUT LATCHES

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER TEST CONDITIONS †		MITIONIC T	SN54LS'			SN74LS'			UNIT	
		TEST CONDITIONS			TYP#	MAX	MIN	TYP\$	MAX	Oldii
Vik		V _{CC} = MIN, I ₁ = - 18 mA			- 1.5			- 1.5	V	
.,	'LS595 Q	V _{CC} = MIN, V _{IH} = 2 V,	10H = - 1 mA	2.4	3.2					
∨он		VIL = MAX	I _{OH} 2.6 mA				2.4	3.1		٧
lavi	^Q H′ ′LS596 Q	V _{CC} = MIN, V _{IH} = 2 V, V _I	1 _{OH} = -1 mA	2.4	3.2	0.1	2.4	3.2	0.1	mA
ТОН	F2236 (1	ACC = MIM' AIH = 5 A' AI		<u> </u>			 	0.25	0.1	mA
	a	V _{CC} = MIN, V _{IH} = 2 V,	IOL = 12 mA		0.25	0.4	-	0.25	0.4	
Vol	VO: +	VII = MAX	101 = 8 mA		0.25	0.4		0.25	0.4	V
	QH'	TIE MAN	I _{OL} = 16 mA					0.35	0,5	
lozh	'LS595 Q	VCC = MAX, VIH = 2 V, VI	L = MAX, V _{OH} = 2.7 V			20			20	μA
IOZL	'LS595 Q	V _{CC} = MAX, V _{IH} = 2 V, V _{II}	L = MAX, V _{OH} = 0.4 V			- 20			- 20	μА
li .		VCC = MAX, VI = 7 V				0.1			0.1	mA
ЧН		V _{CC} - MAX, V ₁ - 2.7 V				20			20	μΑ
IJЦ	SER	SER V _{CC} = MAX, V ₁ = 0.4 V				- 0.4			- 0.4	mΑ
' '1 <u> </u> 	All others	· (C 141/14)				- 0.2	<u> </u>		- 0.2	
los §	'LS595 Q	V _{CC} = MAX, V _O = 0 V		- 30		130	- 30		– 130	mΑ
.05	QH,			- 20		- 100	- 20		– 10 0	1117 5
¹ ссн	'LS595				33	50		33	50	mΑ
ССП	'LS596	$V_{CC} = MAX$			30	45		30	45	
ICCL	'LS595	All possible inputs grounded,			42	65		42	65	mA
	'LS596	All outputs open			36	55		36	55	
¹ccz	'L S 595				44	65		44	65	mA.

[†] For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions,

[‡] All typical values are at $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ}\text{C}$.
§ Not more than one output should be shorted at a time, and duration of the short-circuit should not exceed one second.

SN54LS595, SN54LS596, SN74LS595, SN74LS596 8-BIT SHIFT REGISTERS WITH OUTPUT LATCHES

switching characteristics, VCC = 5 V, TA = 25° C (see note 3)

PARAMETER	FROM	TO (OUTPUT)	TEST CONDITIONS		'LS595			'LS596			UNIT	
	(INPUT)				MIN	TYP	MAX	MIN	TYP	MAX	CIVIT	
^t PLH	SRCK1	CDCV A		D = 150	C: = 20 nE		12	18		14	21	ns
^t PHL		QH'	$R_L = 1k\Omega$,	C _L = 30 pF		17	25		20	30	ns	
t _{PLH}	RCK 1	Q _A thru Q _H	$R_1 = 667 \Omega$	Ω, C _L = 45 pF	1	12	18		28	42	ns	
^t PHL						24	35		24	35	ns	
tPZH	₫ţ	Q _A thru Q _H	111 - 007 12,			20	30				пs	
^t PZL		GA (III GH				25	38				ns	
^t PHZ	G t	Q _A thru Q _H	$R_1 = 667 \Omega$,	CL = 5 pF		20	30_				ns	
tpLZ		CA INTO CH	,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,	СГ - 2 БЕ	[-	25	38				ns	
tPLH .	G١	Q _Д thru Q _Н	$R_L = 667 \Omega$,	C _L = 45 pF			·		40	60	ns	
^t PHL	Ğ↓	Q _A thru Q _H							25	38	ns	
^t PHL	SRCLR +	QH'	$R_{\perp} = 1 k\Omega$,	C _L = 30 pF		24	35		24	35	ns	

NOTE 3: Load circuits and voltage waveforms are shown in Section 1.

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